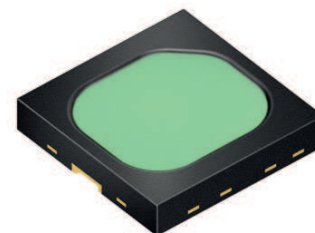


# OSLON Black Flat (IR broad band emitter) - 120° Version 1.1

## SFH 4735



### Features:

- SMD epoxy package
- ThinGaN (UX:3)
- Wide viewing angle of 120°
- Improved Corrosion Robustness
- Low thermal resistance (Max. 9 K/W)

### Applications

- Illumination source for spectroscopy

### Notes

Depending on the mode of operation, these devices emit highly concentrated non visible infrared light which can be hazardous to the human eye. Products which incorporate these devices have to follow the safety precautions given in IEC 60825-1 and IEC 62471.

### Ordering Information

Type:	Total Radiant Flux $\Phi_e$ [mW] $I_F = 350 \text{ mA}, t_p = 20 \text{ ms}$	Ordering Code
SFH 4735	200	Q65111A9885

Note: Measured with integrating sphere.

**Maximum Ratings** ( $T_A = 25\text{ °C}$ )

Parameter	Symbol	Values	Unit
Operation and storage temperature range	$T_{op}; T_{stg}$	-40 ... 85	°C
Junction temperature	$T_j$	125	°C
Forward current	$I_F$	500	mA
Surge current ( $t_p \leq 1\text{ ms}$ , $D = 0$ )	$I_{FSM}$	1	A
Power consumption	$P_{tot}$	1900	mW
ESD withstand voltage (acc. to ANSI/ ESDA/ JEDEC JS-001 - HBM)	$V_{ESD}$	2	kV
Thermal resistance junction - soldering point	$R_{thJS}$	9	K / W

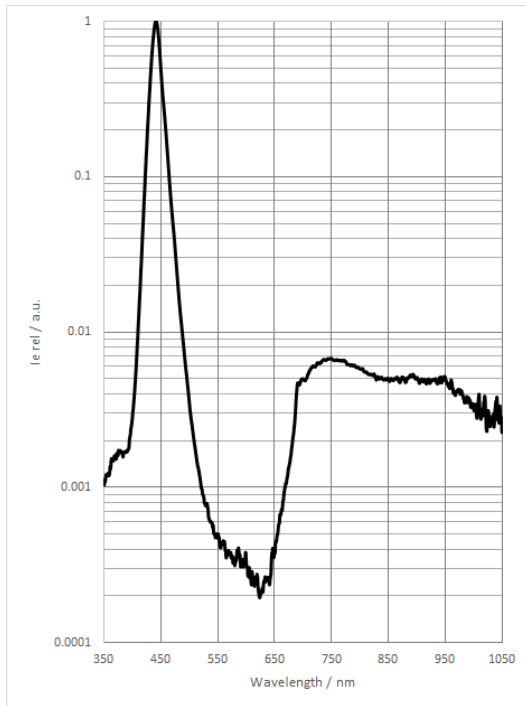
Note: For the forward current and power consumption please see "maximum permissible forward current" diagram

**Characteristics** ( $T_A = 25\text{ °C}$ )

Parameter	Symbol	Values	Unit
Half angle (typ)	$\phi$	$\pm 60$	°
Forward voltage ( $I_F = 350\text{ mA}$ , $t_p = 20\text{ ms}$ ) (typ (max))	$V_F$	$2.95 (\leq 3.5)$	V
Forward voltage ( $I_F = 500\text{ mA}$ , $t_p = 100\text{ }\mu\text{s}$ ) (typ (max))	$V_F$	$3 (\leq 3.8)$	V
Reverse current ( $V_R = 5\text{ V}$ )	$I_R$	not designed for reverse operation	$\mu\text{A}$
Radiant intensity ( $I_F = 350\text{ mA}$ , $t_p = 20\text{ ms}$ , $\lambda = 350 - 600\text{ nm}$ )	$I_{e, typ}$	59	mW/sr
Radiant intensity ( $I_F = 350\text{ mA}$ , $t_p = 20\text{ ms}$ , $\lambda = 600 - 1050\text{ nm}$ )	$I_{e, typ}$	5	mW/sr
Total radiant flux ( $I_F = 350\text{ mA}$ , $t_p = 20\text{ ms}$ , $\lambda = 350 - 600\text{ nm}$ ) (typ)	$\Phi_e$	184	mW
Total radiant flux ( $I_F = 350\text{ mA}$ , $t_p = 20\text{ ms}$ , $\lambda = 600 - 1050\text{ nm}$ ) (typ)	$\Phi_e$	16	mW
Spectral flux ( $I_F = 350\text{ mA}$ , $t_p = 20\text{ ms}$ , $\lambda = 750\text{ nm}$ ) (typ)	$\Phi_{e, \lambda}$	60	$\mu\text{W/nm}$
Spectral flux ( $I_F = 350\text{ mA}$ , $t_p = 20\text{ ms}$ , $\lambda = 850\text{ nm}$ ) (typ)	$\Phi_{e, \lambda}$	45	$\mu\text{W/nm}$
Spectral flux ( $I_F = 350\text{ mA}$ , $t_p = 20\text{ ms}$ , $\lambda = 950\text{ nm}$ ) (typ)	$\Phi_{e, \lambda}$	45	$\mu\text{W/nm}$

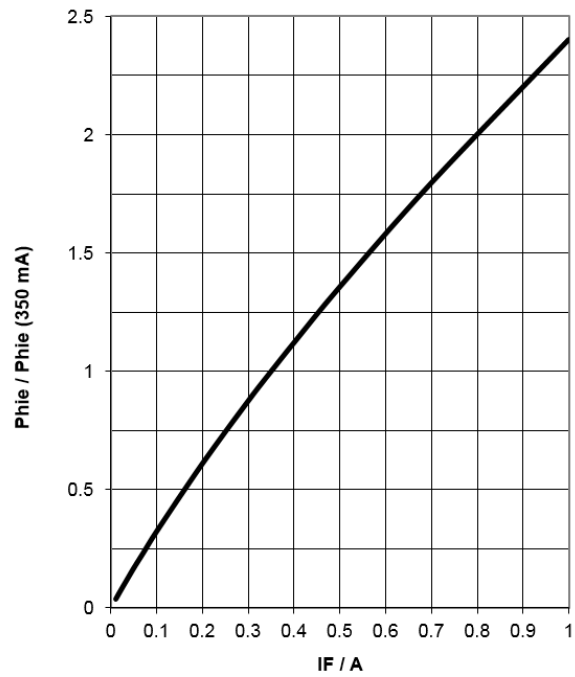
**Relative Spectral Emission** <sup>1) page 12</sup>

$I_{rel} = f(\lambda)$ ,  $T_A = 25\text{ }^\circ\text{C}$ ,  $I_F = 350\text{ mA}$ ,  $t_p = 10\text{ ms}$



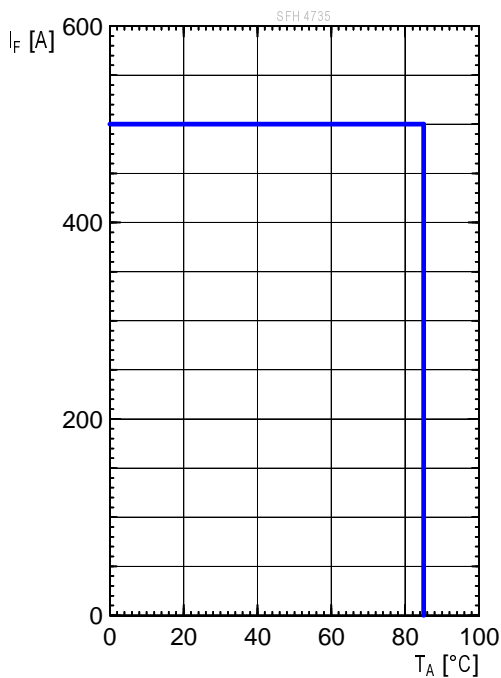
**Relative Total Radiant Flux** <sup>1) page 12</sup>

$\Phi_e / \Phi_e(350\text{mA}) = f(I_F)$ ,  $T_A = 25\text{ }^\circ\text{C}$ , Single pulse,  $t_p = 100\text{ }\mu\text{s}$



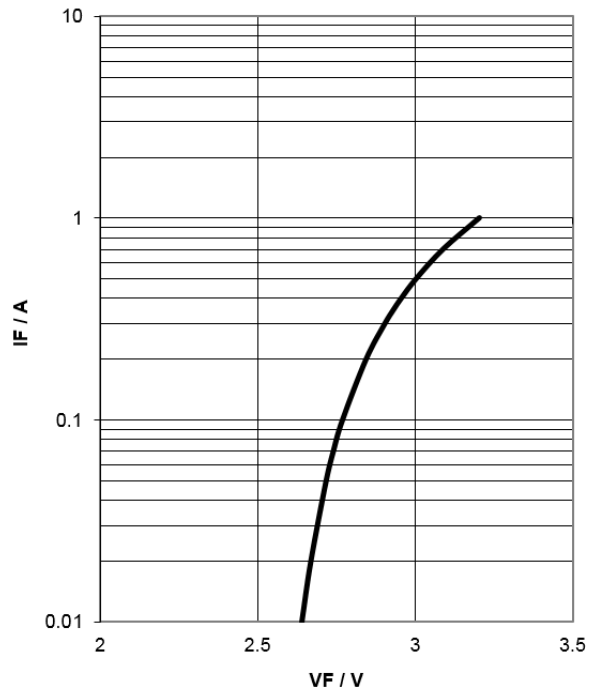
**Max. Permissible Forward Current**

$I_F = f(T_S)$ ,  $R_{thJS} = 9\text{ K/W}$



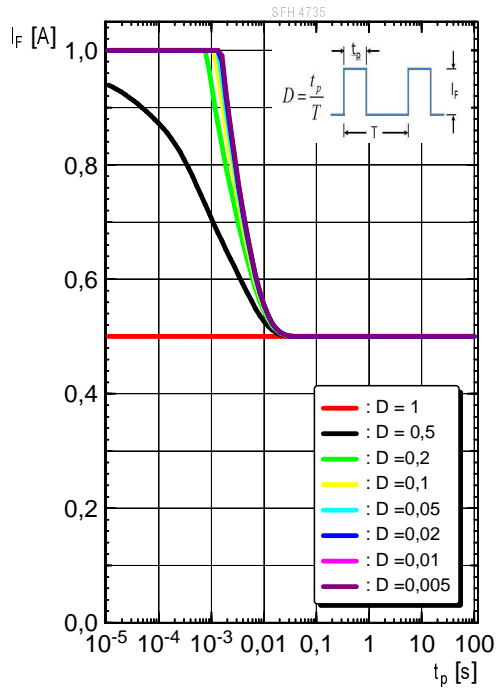
**Forward Current** <sup>1) page 12</sup>

$I_F = f(V_F)$ , single pulse,  $t_p = 100\text{ }\mu\text{s}$ ,  $T_A = 25\text{ }^\circ\text{C}$



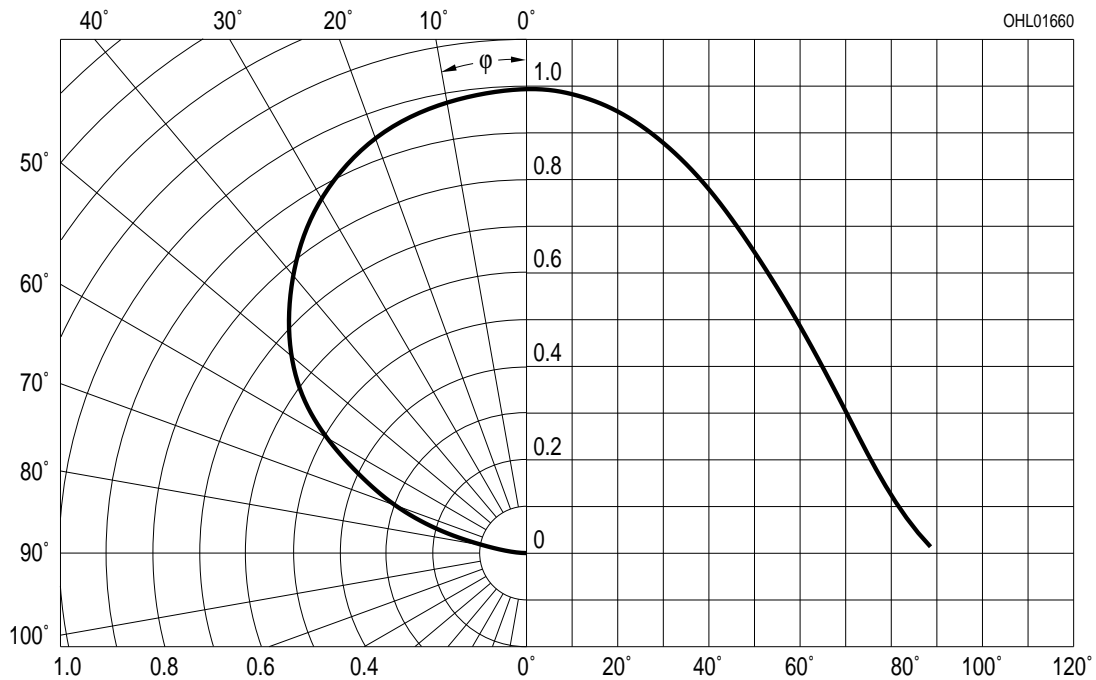
**Permissible Pulse Handling Capability**

$I_F = f(t_p)$ ,  $T_A = 85\text{ °C}$ , duty cycle  $D = \text{parameter}$

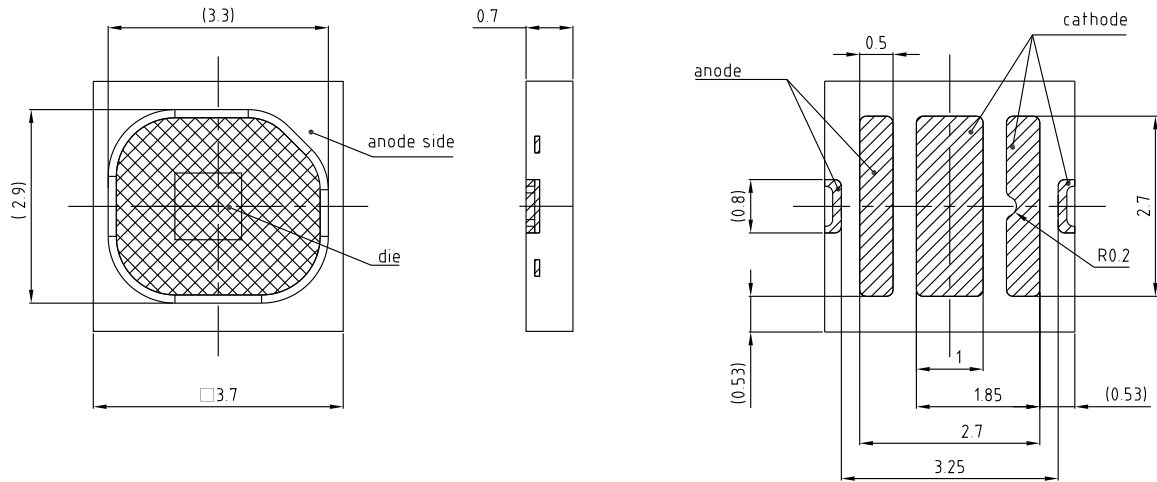


**Radiation Characteristics** <sup>1) page 12</sup>


$I_{rel} = f(\phi)$ ,  $T_A = 25\text{ °C}$



## Package Outline



general tolerance  $\pm 0.1$

lead finish Au 

C67062-A0189-A103

Dimensions in mm.

**Type:**

SFH 4735

**Package**

OSLON Black Flat

**Approximate Weight:**

0.2 g

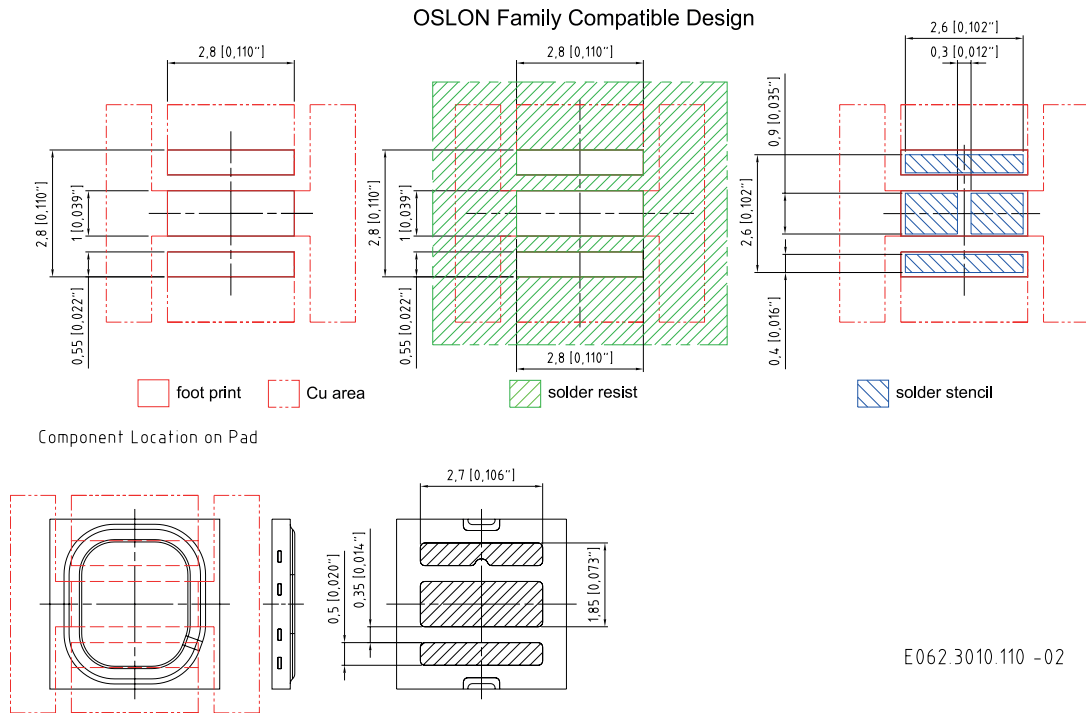
**Package marking**

see drawing

**Note:**

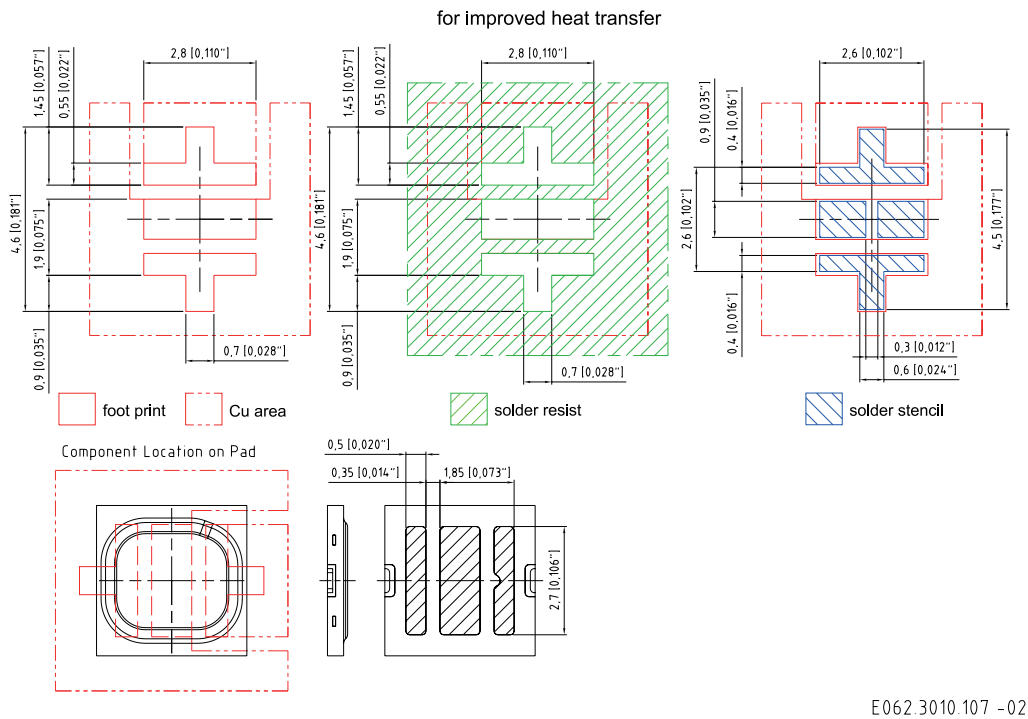
IREL is protected by ESD device which is connected in parallel to chip.

**Recommended Solder Pad**



For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere.

**Recommended Solder Pad**

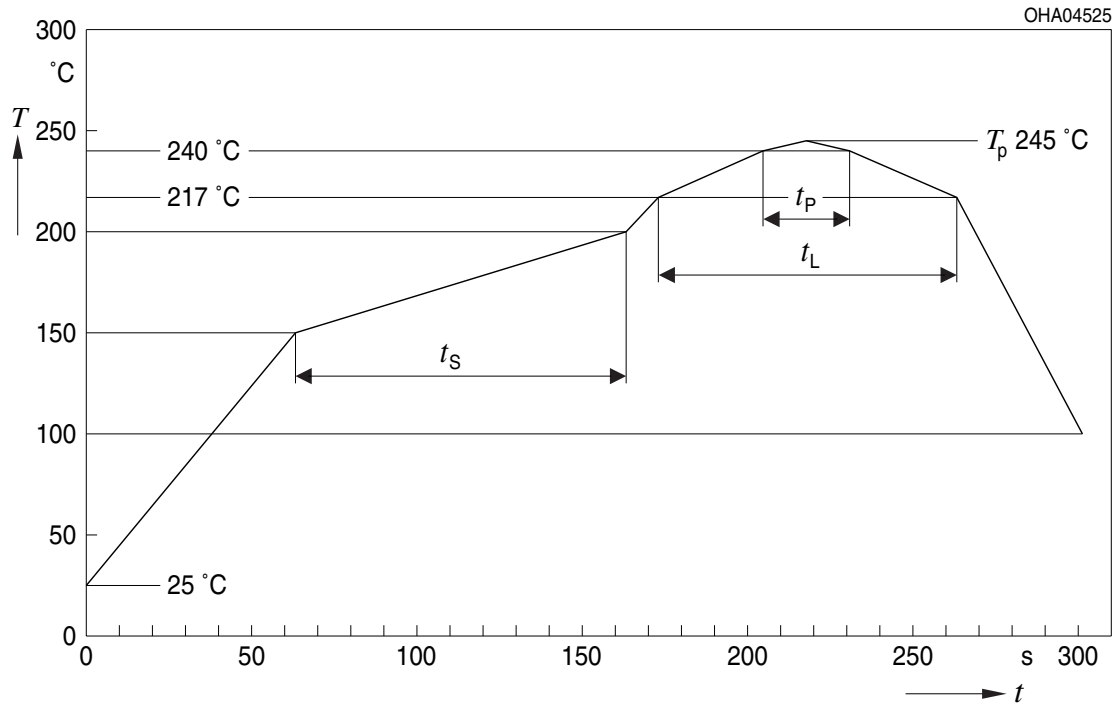


**Note:**

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere.

**Reflow Soldering Profile**

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



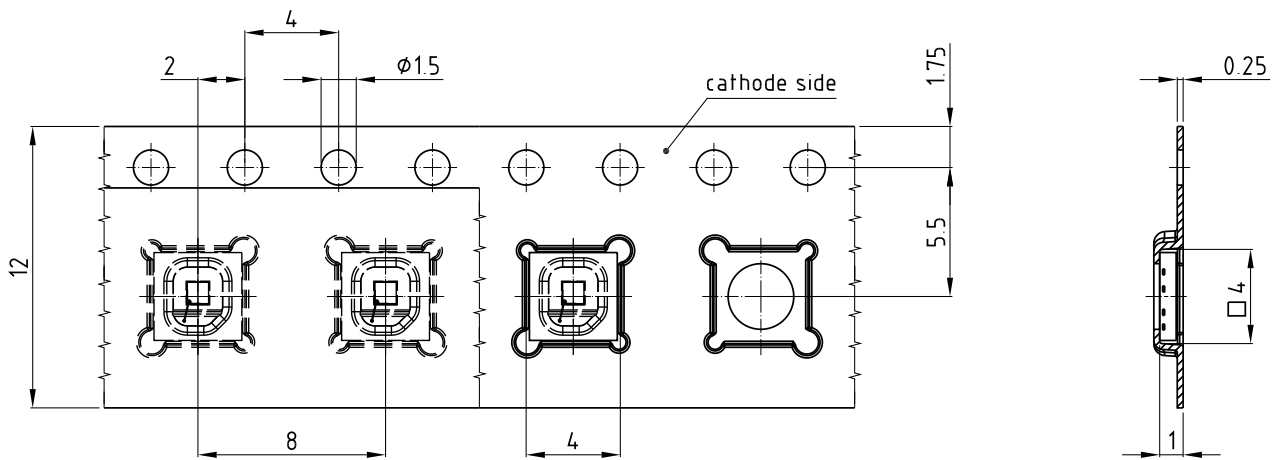
OHA04612

Profile Feature Profil-Charakteristik	Symbol Symbol	Pb-Free (SnAgCu) Assembly			Unit Einheit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time $t_S$ $T_{Smin}$ to $T_{Smax}$	$t_S$	60	100	120	s
Ramp-up rate to peak*) $T_{Smax}$ to $T_P$			2	3	K/s
Liquidus temperature	$T_L$		217		°C
Time above liquidus temperature	$t_L$		80	100	s
Peak temperature	$T_P$		245	260	°C
Time within 5 °C of the specified peak temperature $T_P - 5$ K	$t_P$	10	20	30	s
Ramp-down rate* $T_P$ to 100 °C			3	6	K/s
Time 25 °C to $T_P$				480	s

All temperatures refer to the center of the package, measured on the top of the component

\* slope calculation  $DT/Dt$ :  $Dt$  max. 5 s; fulfillment for the whole T-range

Taping

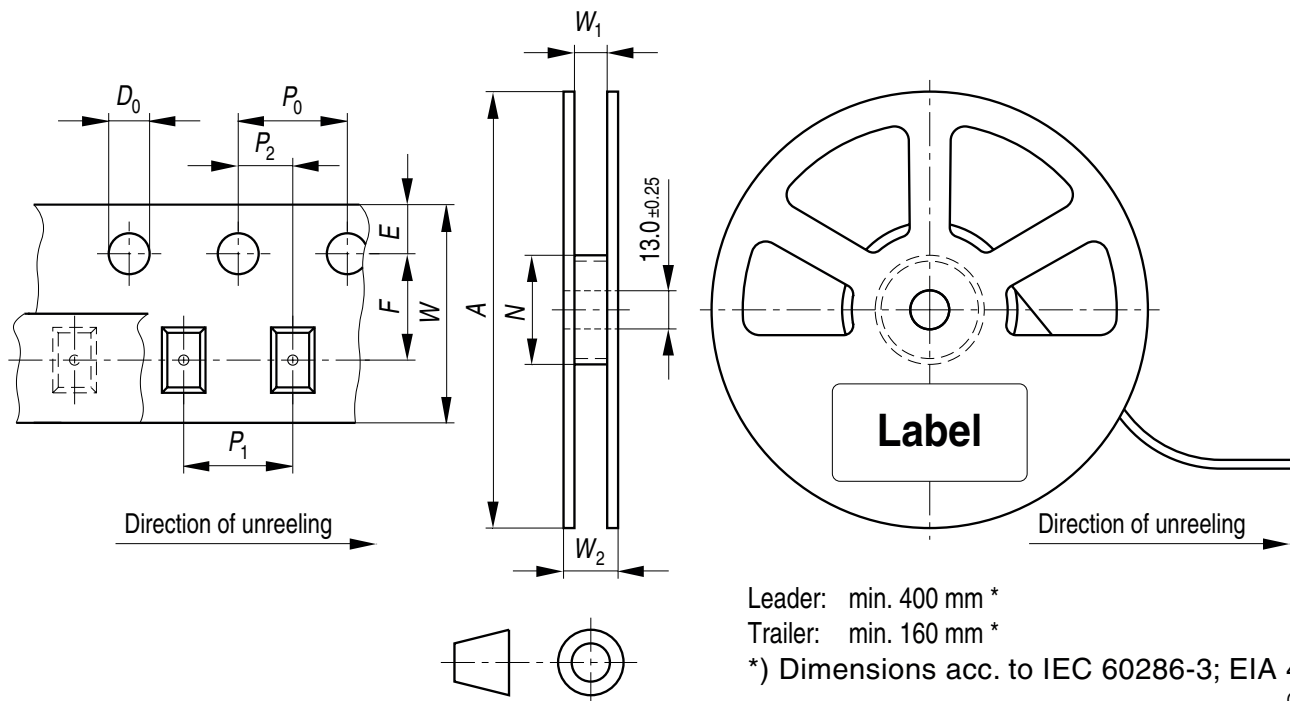


C67062-A0030-B11-06

Dimensions in mm.

Tape and Reel

12 mm tape with 2000 pcs. on  $\phi$  180 mm reel





## Tape dimensions [mm]

W	P <sub>0</sub>	P <sub>1</sub>	P <sub>2</sub>	D <sub>0</sub>	E	F
12 + 0.3 / - 0.1	4 ± 0.1	4 ± 0.1 or 8 ± 0.1	2 ± 0.05	1.5 ± 0.1	1.75 ± 0.1	5.5 ± 0.05

## Reel dimensions [mm]

A	W	N <sub>min</sub>	W <sub>1</sub>	W <sub>2max</sub>
180	12	60	12.4 + 2	18.4

## Barcode-Product-Label (BPL)



## Dry Packing Process and Materials



## Note:

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card. Regarding dry pack you will find further information in the internet. Here you will also find the normative references like JEDEC.

## Transportation Packing and Materials



## Dimensions of transportation box in mm

Width	Length	Height
195 ± 5	195 ± 5	30 ± 5

**Disclaimer**

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

**Attention please!**

The information describes the type of component and shall not be considered as assured characteristics.

Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version in the Internet.

**Packing**

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office.

By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

**Components used in life-support devices or systems must be expressly authorized for such purpose!**

Critical components\* may only be used in life-support devices\*\* or systems with the express written approval of OSRAM OS.

\*) A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or the effectiveness of that device or system.

\*\*) Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health and the life of the user may be endangered.

**Glossary**

- <sup>1)</sup> **Typical Values:** Due to the special conditions of the manufacturing processes of LED, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

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EU RoHS and China RoHS compliant product



此产品符合欧盟 RoHS 指令的要求；  
按照中国的相关法规和标准，不含有毒有害物质或元素。

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- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
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«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

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